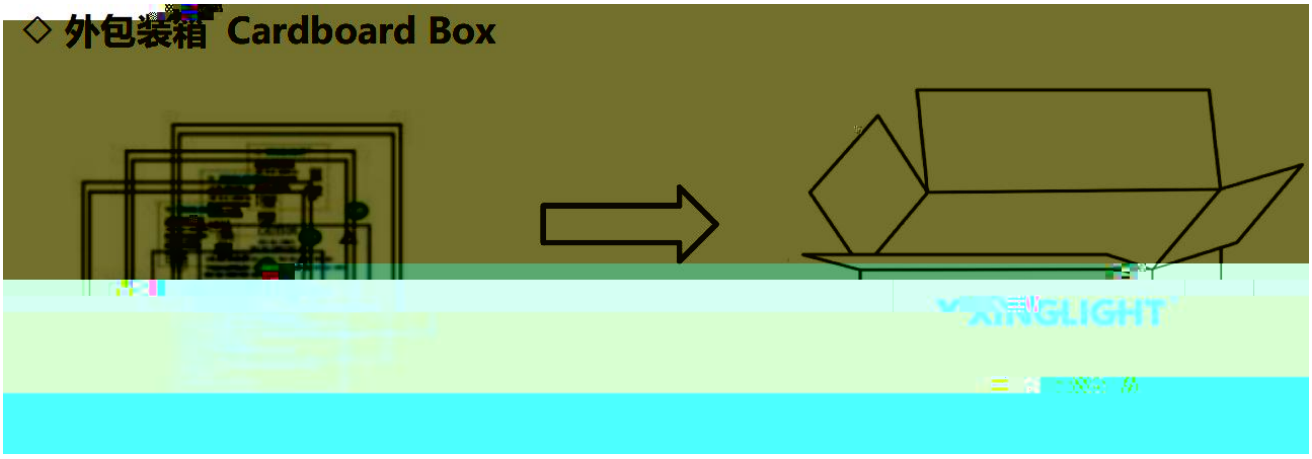
包装（2）

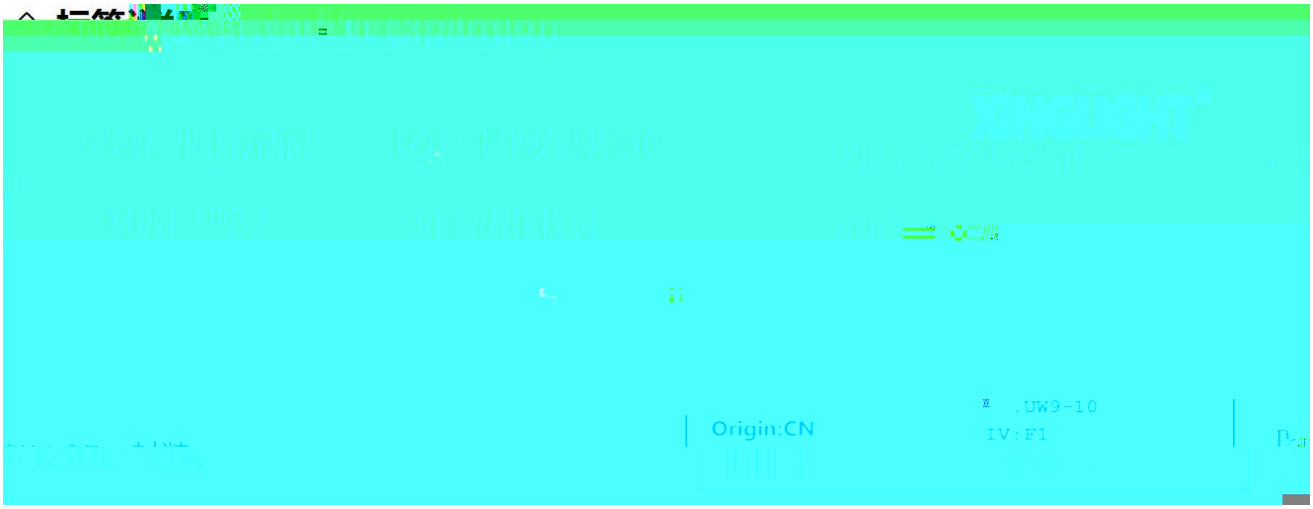
Packaging (2)

◇ 防潮抗静电包装 Moisture Proof and Anti-Electrostic Foil Bag

◇ 外包装箱 Cardboard Box



◇ 标签 Label



焊接指导（2）

Guideline for Soldering (2)

[redacted]

30 3 50

[redacted]

30

LED

300W LED

LED

It is recommended that alcohol be used as a solvent for cleaning after soldering. Cleaning is to go under 30 for 3 minutes or 50 for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

Ultrasonic cleaning is also an effective way for cleaning. But the influence of Ultrasonic cleaning on LED depends on factors such as ultrasonic power. Generally, the ultrasonic power should not be higher than 300W. Before cleaning, a pretest should be done to confirm whether any damage to LEDs will occur.

* 注意： PCB

使用注意事项（1）
Precautions (1)

[redacted]

Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.

30 60%RH

Before opening the package, the product should be kept at 30 or less and humidity less than 60% RH, and be used within a year.

30 40%RH 168 7

30 60%RH

After opening the package, the product should be stored at 30 or less and humidity less than 40%RH, and be soldered within 168 hours (7 days). It is recommended that the product be operated at the workshop condition of 30 or less and humidity less than 60%RH.

LED

60 5 24

If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (60 5) for 24 hours.

静电：

Static electricity or surge, [redacted]

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